

Silicon Detectors for the Large Prototype TPC test setup at DESY

S. Haensel¹, T. Bergauer¹, M. Dragicevic¹, J. Hrubec¹, M. Krammer¹,
A. Dierlamm², T. Barvich², F. Hartmann², Th. Müller²

1 - Institute of High Energy Physics of the Austrian Academy of Sciences (HEPHY)
Nikolsdorfergasse 18, 1050 Vienna - Austria

2 - Institut für Experimentelle Kernphysik - Forschungszentrum Karlsruhe (IEKP)
Hermann-von-Helmholtz-Platz 1, 76344 Eggenstein-Leopoldshafen - Germany

The Linear Collider TPC collaboration constructed a Large Prototype TPC (LPTPC) which is now installed at the EUDET facility, in DESY. The SiLC-collaboration (Silicon for the Linear Collider) will install position sensitive silicon strip sensors outside the field cage of the LPTPC, to provide precise tracking information. The data acquisition system (DAQ) is an adapted CMS readout system. The silicon modules are tested and ready to be installed, the mechanical module support and the DAQ system are in preparation.

1 Introduction

The present paper describes the work of the SiLC-collaboration[2] for the participation in the LPTPC test setup, with the purpose to participate at the LPTPC test setup at the EUDET facility in DESY. The SiLC-collaboration will design, build and install position sensitive silicon strip modules in the small gap between the LPTPC and the surrounding magnet complementing the data provided by the TPC. In the envisaged setup it will be possible to test modules with different sensors and readout chips. Furthermore it will allow to evaluate a first prototype of an external layer surrounding the TPC, as foreseen in the ILD concept, and to verify the corresponding simulations.

2 The setup

The EUDET facility with the LPTPC test setup is located in a reserved DESY II test beam area. Converted bremsstrahlung-electrons from the accelerator will reach the test setup with an adjustable momentum between 1 and 6 GeV with a spread of about 2 % and a divergence of 2 mrad. The estimated average rates for 6 GeV electrons are 250 Hz. The Large Prototype TPC with its support structure inside the magnet is shown in Fig. 1. The magnet is a Persistent Current, superconducting MAGnet (PCMAG), which will provide an inhomogeneous B-field of 1 Tesla. The space between the magnet and the TPC is just 35 mm in radius, thus leaving very little space for the silicon detectors and their appropriate support structure. The magnet can

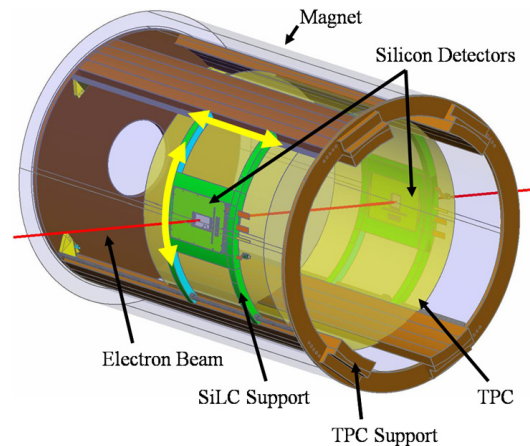


Figure 1: LPTPC setup

move in all directions in order to provide a scanning of the TPC. Hence the behaviour of the TPC can be investigated in the different regions of the inhomogeneous magnetic field.

An area of approximately $10 \times 20 \text{ mm}^2$ will be covered with silicon sensors, whereof in the beginning only a width of 38.4 mm is read out. This setup will simulate the part of the silicon envelope on either side of the TPC. In order to keep these two silicon modules aligned to the beam axis, the mechanical support structure of the silicon has to compensate for the movements of the magnet.

3 Sensor tests

Each of the two detector modules consists of six silicon strip sensors. These single sided AC coupled silicon strip sensors with a size of $91.5 \times 91.5 \times 0.320 \text{ mm}^3$ were designed by the SiLC-collaboration and manufactured by Hamamatsu Photonics, Japan. Each sensor has 1792 readout strips with a readout pitch of $50 \mu\text{m}$, without intermediate strips, biased with a $20 \text{ M}\Omega$ poly-silicon resistor. Prior to the module assembly, the sensors showed leakage currents below 300 nA up to an biasing voltage of 800 V and full sensor depletion at an average depletion voltage of 55 V . Single strip measurements revealed single strip currents of around 130 pA (at 100 V), values for the poly silicon resistors of above $20 \text{ M}\Omega$ and coupling capacitances in the order of 150 pF , indicating the excellent quality of the sensors.

4 Detector modules

The two detector modules (Fig. 2) each consist of a one-sensor and a two-sensor silicon detector and will be screwed onto the moveable support structure. They will be aligned in the beam axis in the small gap between the TPC and the magnet, one in front and one behind the TPC, to provide precise tracking information. The silicon sensors have a spatial resolution of $9 \mu\text{m}$. This value was determined during a SiLC test beam at the SPS in 2008 [3]. To provide this resolution in both directions ($R\phi$ and z), the two silicon detectors in each module are assembled at an angle of 90° . The horizontal detector, consisting of two daisy-chained sensors, is located closer to the magnet than the other silicon detector, which is composed of one sensor.

Each silicon detector consists of two carbon fibre T-beams as basic support. The sensor(s), the pitch adapter and the readout electronics are glued onto these T-profiles. In a

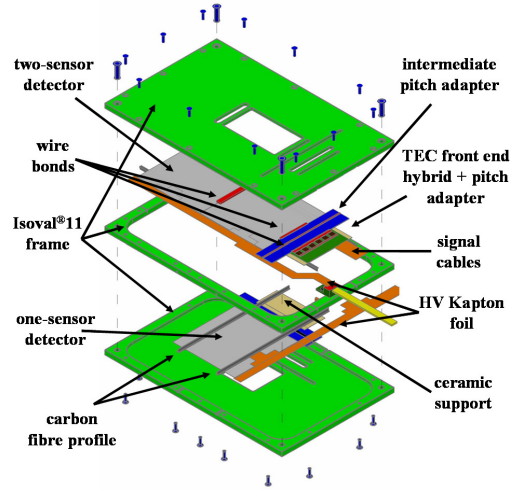


Figure 2: Silicon module layout

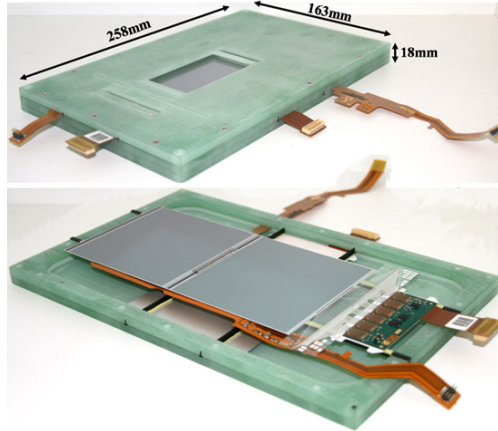


Figure 3: Top: closed silicon module without light-tight cover; bottom: module without top layer of the frame

following step of the module assembly these T-beams are clamped between three layers of the module frame (produced with Isoval11). Because new readout chips are not yet available, the first four detectors were constructed with front end hybrids from the CMS Tracker End Cap module production. Each of these hybrids contains 6 APV25 readout chips, providing a total of 768 readout channels, and can be read out by an adapted CMS readout system. It is not possible to use two of these hybrids side by side, therefore the sensitive silicon area per detector is reduced to 38.4 mm. The hybrids from the CMS production are connected to a pitch adapter designed to connect to a sensor with 143 μm pitch. A further intermediate pitch adapter was therefore necessary to adapt to the pitch of 50 μm of the used sensors. Kapton foils from the CMS module production are used to deliver the HV bias voltage to the sensor backplane and to isolate the sensor backplane from the carbon fibre profiles. Each HV-line contains a RC circuit to stabilize voltage fluctuations and to filter out high frequencies in the HV line. Fig. 3 shows a finalised detector module, which has a thickness of 18 mm plus around 2 mm for a light-tight adhesive foil.

The two silicon modules were electronically tested: the leakage current of the silicon modules is below 1.5 μA at 450 V and the noise of the readout strips is as low as required (Fig. 4). In the noise plot a few channels with a very low noise indicate readout channels which are not connected to the readout chip. Investigations revealed defects on the intermediate pitch adapter. Since there are no clusters of disconnected readout channels in the central region of the sensors, the detector modules are well suited for this setup.

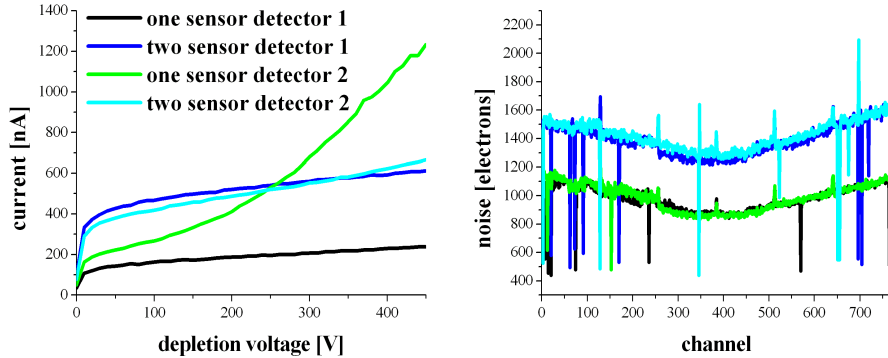


Figure 4: Electrical measurements of the silicon detectors - as expected, the detectors with two sensors have a higher current at 100 V and a higher noise than the detectors with one sensor

5 Mechanical support of the silicon modules

The mechanical support has to position the two detector modules on each side of the TPC inside the gap of 35 mm between the magnet and the TPC. Since the sensitive areas of the modules have to be in the beam line, the support has to compensate vertical and horizontal movements and even horizontal rotations of the magnet.

Design studies for this support are ongoing. The detector modules are constructed in a way that they leave a safety clearance of at least 4 mm to the TPC and the surrounding magnet. The $R\varphi$ -position of the modules will be assigned by screwing them at different positions onto a curved sledge. This sledge will then be moved manually in and out of the magnet along two sliding rails, which will be mounted on the TPC support structure.

